Ref #	Hits	Search Query	DBs	Default Operator	Plurals	Time Stamp
S1	1985	430/320	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWEN T; IBM_TDB	OR	ON	2007/01/19 12:09
S10	2	("6333135").PN.	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWEN T; IBM_TDB	OR	OFF	2007/01/16 11:51
S11	2	("6514658").PN.	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWEN T; IBM_TDB	OR	OFF	2007/01/16 11:59
S12	2	("6849383").PN.	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWEN T; IBM_TDB	OR	OFF	2007/01/16 13:47
S13		("7056649").PN.	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWEN T; IBM_TDB	OR	OFF	2007/01/16 13:47
S14	1019734	mold	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWEN T; IBM_TDB	OR	ON	2007/01/16 14:01

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S15	1010362	photoresist or photosensitive or resist or photopolymer	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWEN T; IBM_TDB	OR	ON	2007/01/18 11:24
S16	787	S14 near S15	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWEN T; IBM_TDB	OR	ON	2007/01/17 14:06
S18	2	("6432328").PN.	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWEN T; IBM_TDB	OR	OFF	2007/01/17 09:11
S20	2	("20030086030").PN.	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWEN T; IBM_TDB	OR	OFF	2007/01/17 09:13
S21	2	("20030020189").PN.	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWEN T; IBM_TDB	OR	OFF	2007/01/17 09:13
S22	2	("5521030").PN.	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWEN T; IBM_TDB	OR .	OFF	2007/01/17 09:55
S23	2	("5071597").PN.	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWEN T; IBM_TDB	OR	OFF	2007/01/17 09:55

S24	2	("4815849").PN.	US-PGPUB;	OR	OFF	2007/01/17 10:56
324		( +013047 ).PIN.	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWEN T; IBM_TDB	·	OFF	2007/01/17 10:30
S33	222157	(bi or tri or multi) adj3 (layer\$3 or level\$3)	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWEN T; IBM_TDB	OR	ON	2007/01/17 14:45
S34	1010362	photoresist or photosensitive or resist or photopolymer	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWEN T; IBM_TDB	OR	ON	2007/01/17 14:07
S36	5261	S33 with S34	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWEN T; IBM_TDB	OR	ON	2007/01/17 14:07
S37	219606	(bi or tri or multi) near (layer\$3 or level\$3)	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWEN T; IBM_TDB	OR	ON	2007/01/17 14:42
S38	5246	S37 with S34	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWEN T; IBM_TDB	OR	ON	2007/01/17 14:19
S40	2	("57185981").PN.	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWEN T; IBM_TDB	OR	OFF	2007/01/17 14:22

S46	1690	S37 near S34	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWEN T; IBM_TDB	OR	ON	2007/01/17 14:43
· S48	211791	(bi or tri or multi) adj (layer\$3 or level\$3)	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWEN T; IBM_TDB	OR	ON	2007/01/17 14:46
S49	1544	S48 near S34	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWEN T; IBM_TDB	OR	ON	2007/01/17 17:20
S53	106	S48 near S34 and mold	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWEN T; IBM_TDB	OR	ON .	2007/01/17 16:59
S56	682	abras\$3 near etch\$3	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWEN T; IBM_TDB	OR	ON	2007/01/18 11:24
S57	1010933	photoresist or photosensitive or resist or photopolymer	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWEN T; IBM_TDB	OR	ON	2007/01/18 11:24
S58	2	S56 near S57	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWEN T; IBM_TDB	OR	ON	2007/01/18 11:26

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S59	245	S56 and S57	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWEN T; IBM_TDB	OR	ON	2007/01/18 11:26
S60	2	("5415971").PN.	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWEN T; IBM_TDB	OR	OFF	2007/01/19 12:10
S61	2	("5989689").PN.	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWEN T; IBM_TDB	OR	OFF	2007/01/19 12:12
S62	2	("6037106").PN.	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWEN T; IBM_TDB	OR	OFF	2007/01/19 12:12
S63	2	("6140006").PN.	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWEN T; IBM_TDB	OR	OFF	2007/01/19 12:57
S64	2	("7074358").PN.	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWEN T; IBM_TDB	OR	OFF	2007/01/19 12:57